U.S. Department of Commerce 04-25-2003 Patent and Trademark Office FORM PTO-1595 **IEET** Attorney Docket No. 1-31-92 08409.0029 To the Honorable Commissioner of Pa 102431373 Please record the attached original do ATTN. BOX ASSIGNMENTS Name of conveying party(ies): Name and address of receiving party(ies): Shuo-Lun Tu, Lu-Shan Chiang and Shih-Lin Chu Macronix International Co., Ltd. Name: Additional name(s) of conveying party(ies) attached? □ Yes

No Internal Address: 3. Nature of conveyance: Street Address: No. 16, Li-Hsin Road Science-Based Industrial Park Hsinchu, Taiwan R.O.C. Assignment Merger City: Security Agreement Change of Name State: Zip Code: \Box Other: Additional name(s) & Address(es) attached? **Execution Date:** February 21, 2003 □ Yes ■ No Application number(s) or patent number(s): Patent Application Number(s): B. Patent Number(s): 181711101 04/21/2003 HMARZI1 00000052 10418121 40.00 OP 02 FC:8021 Additional numbers attached? □ Yes No 5. Name and address of party to whom correspondence 6. Total number of applications and registrations involved: concerning document should be mailed: Name: Yitai Hu, Esquire 7. Total fee (37 CFR 3.41): \$40 FINNEGAN, HENDERSON, FARABOW, GARRETT Enclosed (Please charge deficiency to deposit account) Internal Address: & DUNNER, L.L.P. Authorized to be charged to deposit account Street Address: 1300 | Street, N.W. City: Washington, D.C. State: Zip: 20005-3315 8. Deposit Account No.: 06-0916 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Yitai Hu, Reg. No. 40,653 Signature April 18, 2003 Total number of pages including cover sheet, attachments and documents:

> PATENT REEL: 013987 FRAME: 0334

ASSIGNMENT

WHEREAS We, the below named inventors, (hereinafter referred to as Assignors), have made an invention entitled:

METHOD OF INTEGRATING THE FABRICATION PROCESS FOR INTEGRATED CIRCUITS AND MEM DEVICES

for which WE executed an application for United States Letters Patent concurrently herewith; and

WHEREAS, Macronix International Co., Ltd., a corporation of Hsinchu, Taiwan, R.O.C. whose post office address is No. 16, Li-Hsin Road, Science-Based Industrial Park, Hsinchu, Taiwan, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, We, as Assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, our entire right, title, and interest in and to this invention, provisional application Serial No.____, filed ____ (if any), and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of this application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that We have the full right to convey the interest assigned by this Assignment, and We have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, WE HEREBY authorize and request the attorn Attorney in this application to insert here in parentheses (Apparent and application number of said application when known.	· · · · · · · · · · · · · · · · · · ·	and Power of) the filing date
Shuo-Lun TU	Shwo-lun Tu	7/21/03
FULL NAME OF FIRST INVENTOR	INVENTOR'S SIGNATURE	DATE
Lu-Shan CHIANG	Lu-Shan Chiang INVENTOR'S SIGNATURE	>/>1/07
FULL NAME OF SECOND INVENTOR	INVENTOR'S SIGNATURE	DATE
Shih-Lin CHU	Shih-Lin Chu	2/21/03
FULL NAME OF THIRD INVENTOR	INVENTOR'S SIGNATURE	DATE

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